

1SA0606VGB01MB01

◆Outline(L*W*H): 1.6*1.5*0.55 mm

◆Good thermal dissipation & Optical uniformity

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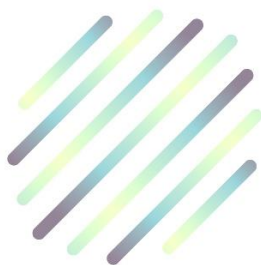
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Features

- Forward current: $\leq 30\text{mA}$
- Typical view angle 50% Iv: 140°
- Lens color code: white diffused
- RoHS2.0 and REACH-compliant
- Qualified according to JEDEC moisturevity Level 2a
- ESD level 1KV(HBM)

Applications

- Indoor signage display applications
- Indoor decorating and entertainment design
- Flat backlight for LCD. Switch and symbol
- Indicator and backlighting for all consumer electronics



■ Product Code Method

1 - S - A - 0606 - VGB0 - 1 - M - B - 01

① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨

①	②	③	④	⑤
Process Type	Category	LED Type	Lead Frame Size	Dice Wavelength & Luminous Rank
1: normal produce	S: SMD LED	A: PCB top view B: PCB side view	0606: 1.6*1.5 mm	V: red G: green B: blue

⑥	⑦	⑧	⑨
Lap Polarity	Cap Color	PCB Module Code	Flow Code
1: common anode	M: white diffused	B: article mode	01: no expression above meaning for company

■ Maximum Rating(Ta=25°C)

Characteristics	Symbol	Rating	Unit
DC Forward Current	I _F	30	mA
Pulse Forward Current ^{*3}	I _{PF}	100	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _D	Red(V)	80
		Green(G)	80
		Blue(B)	100
Operating Temperature Range	T _{OP}	-40-85	°C
Storage Temperature Range	T _{STG}	-40-100	°C
Soldering Temperature ^{*4}	T _{SD}	260	°C

Notes 1: There is no maximum or typical voltage parameter

2: For other ambient, limited setting of current will be depended on de-rating curves.

3: Duty 1/10, pulse width 0.1ms

4: The maximum of soldering time is 5 seconds in T_{SD}

■ Typical Product Characteristics(Ta=25℃)

Characteristics	Symbol		Min.	Typ.	Max.	Unit	Test condition
Leakage Current	I _R		-	-	10	μA	V _R =5V
View angle	2θ _{1/2}		-	140	-	Deg	I _F =5mA
Forward Voltage	V _F	Red(V)	1.6	2.0	2.6	V	I _F =5mA
		Green(G)	2.6	3.0	3.6		I _F =5mA
		Blue(B)	2.6	2.9	3.6		I _F =5mA
Luminous Intensity	I _v	Red(V)	-	40	-	mcd	I _F =5mA
		Green(G)	-	260	-		I _F =5mA
		Blue(B)	-	45	-		I _F =5mA
Dominant Wavelength	λ _d	Red(V)	618	-	628	nm	I _F =5mA
		Green(G)	528.5	-	536.5		I _F =5mA
		Blue(B)	464.5	-	471.5		I _F =5mA

Notes: 1. Measurement Errors:

Forward Voltage: $\pm 0.1V$, Luminous Intensity (I_v) $\pm 10\%$, Dominant Wavelength (λ_d) $\pm 1.0nm$

2. Electrical-Optical Characteristics (Ta=25℃)

■ Range of Bins

1) Luminous Intensity Bins

Red($I_F=5mA$)		
Bin Code	Min.(mcd)	Max.(mcd)
3	33	42
4	42	53

Green($I_F=5mA$)		
Bin Code	Min.(mcd)	Max.(mcd)
5	205	265
6	265	345

Blue($I_F=5mA$)		
Bin Code	Min.(mcd)	Max.(mcd)
3	36	46
4	46	59

2) Dominant Wavelength Bins

Red($I_F=5mA$)		
Bin Code	Min.(nm)	Max.(nm)
3	618	628

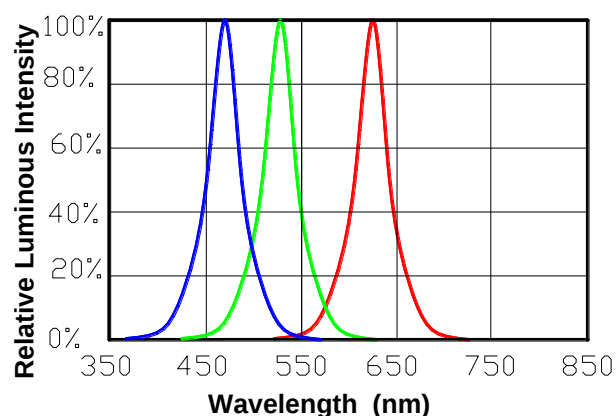
Green($I_F=5mA$)		
Bin Code	Min.(nm)	Max.(nm)
4	528.5	536.5

Blue($I_F=5mA$)		
Bin Code	Min.(nm)	Max.(nm)
3	464.5	471.5

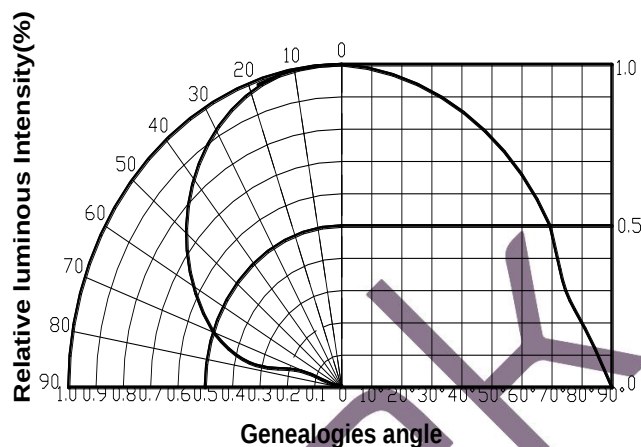
Notes: the red is main range of Bins, and the parameter will have a little change

■ Electrical-Optical Characteristics

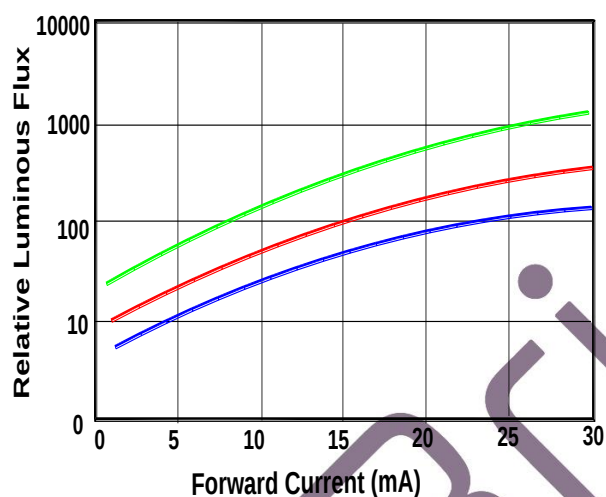
1). Relative Spectral Distribution



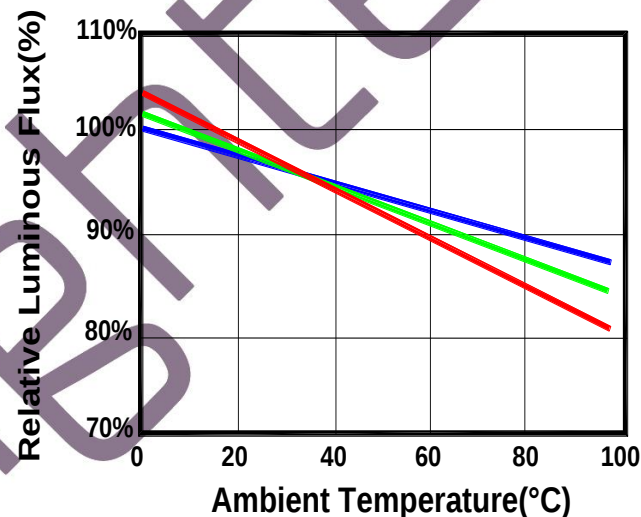
2). Typical Spatial Distribution



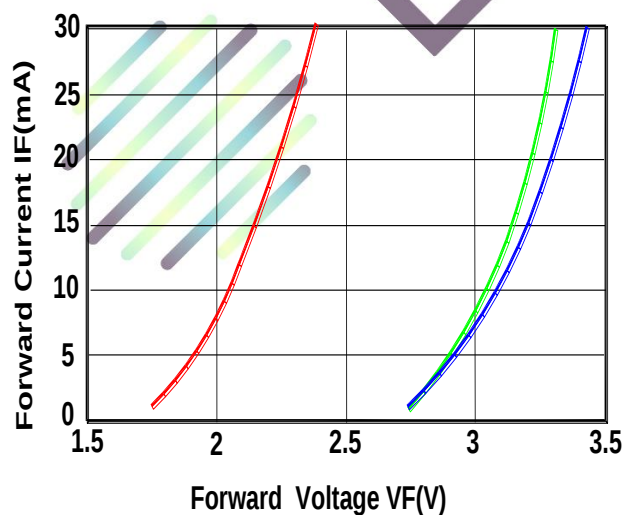
3). Relative Luminous Flux Vs Current



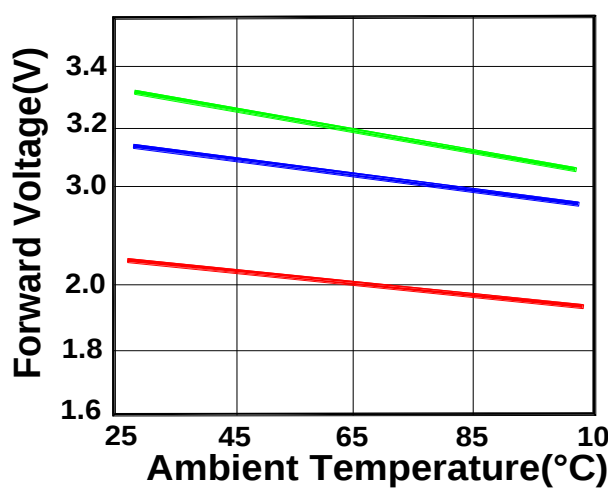
4). Relative Luminous Flux Vs Ambient Temperature



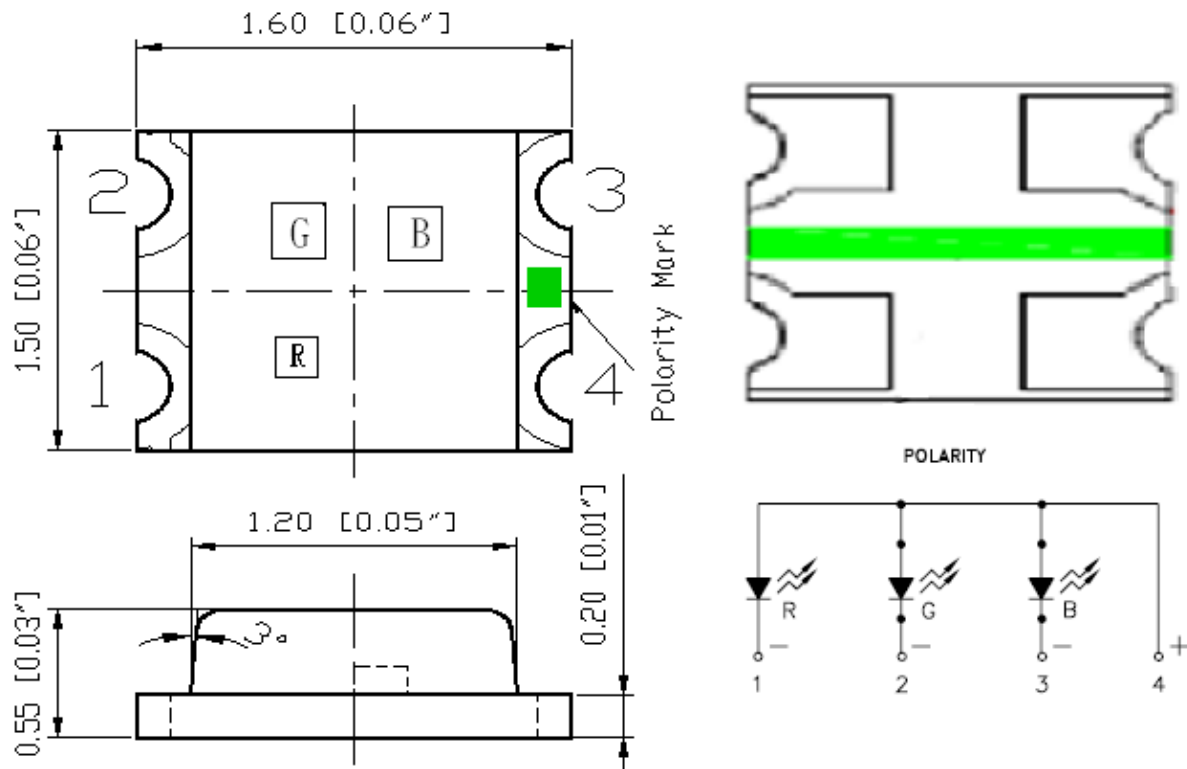
5). Electrical Characteristics



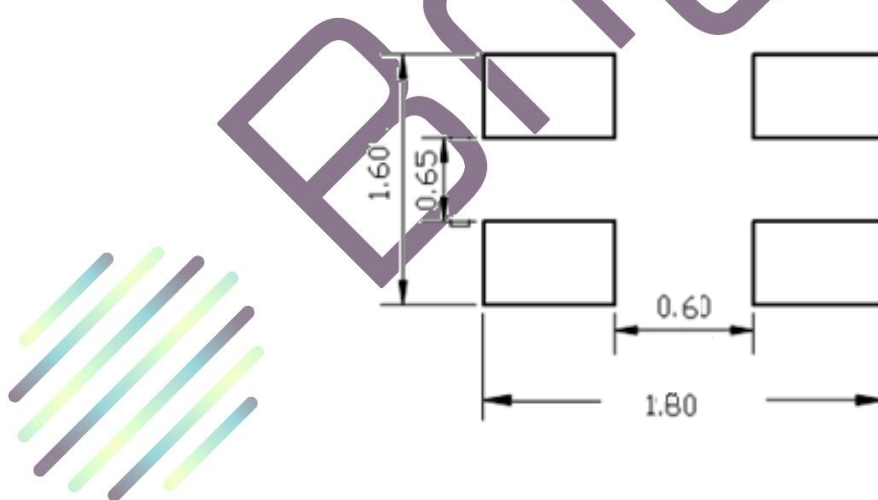
6). Forward Voltage Vs Temperature



■ Dimensions



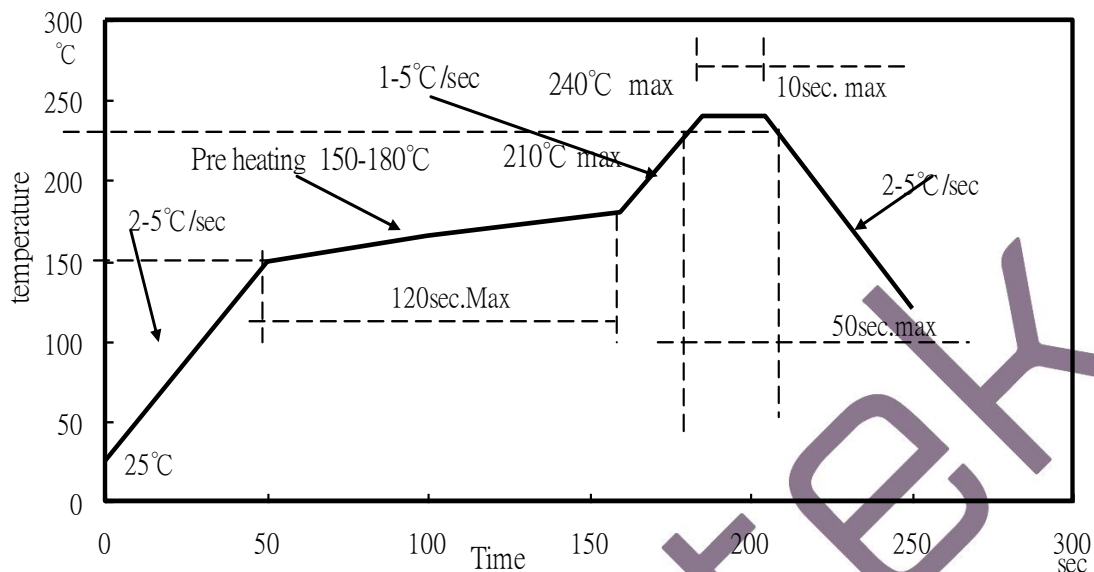
RECOMMEND PAD LAYOUT



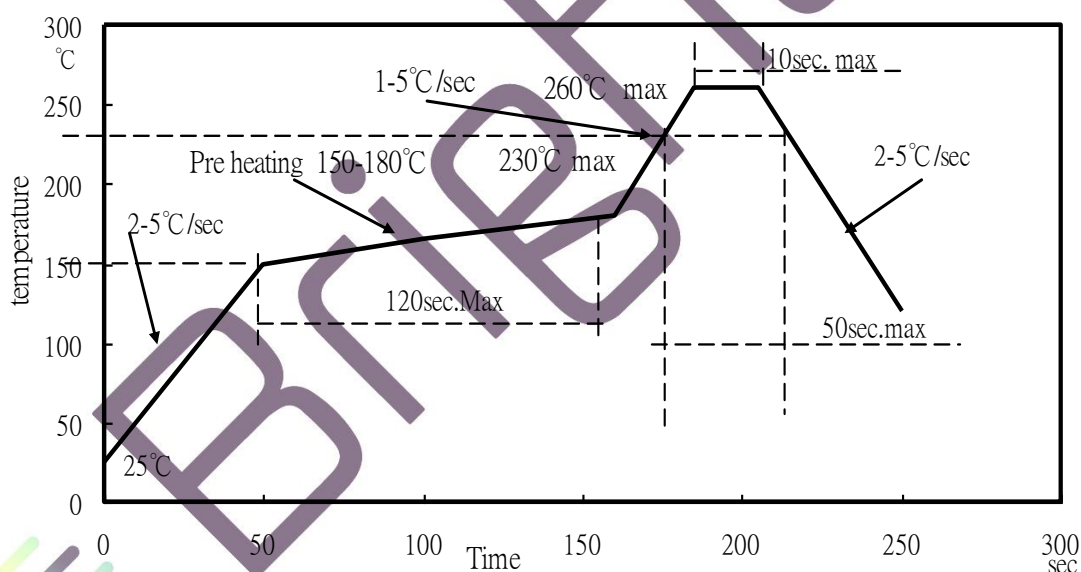
- Notes:
1. All dimensions are in millimeters (inches)
 2. Tolerance is ± 0.1 (± 0.004 ") mm unless otherwise noted
 3. Specifications are subject to change without notice.

■ Reflow Profile

1. I_R reflow soldering profile for lead free solder



2. I_R reflow soldering profile for lead solder

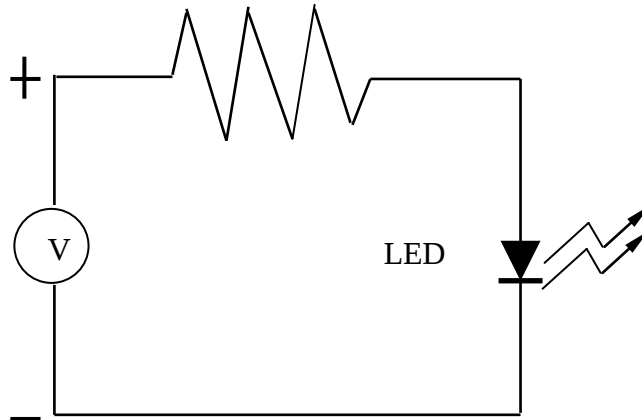


Notes:

1. We recommend the reflow temperature 240°C (±5°C).the maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the silicone resin while it is exposed to high temperature.
3. Number of reflow process shall be less than 3 times.

■ Test Circuit and Handling Precautions

1. Test circuit



2. Handling precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ ($41^{\circ}\text{F} \sim 86^{\circ}\text{F}$)

2). Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and $<60\%$ R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs.

The Conditions are as followings:

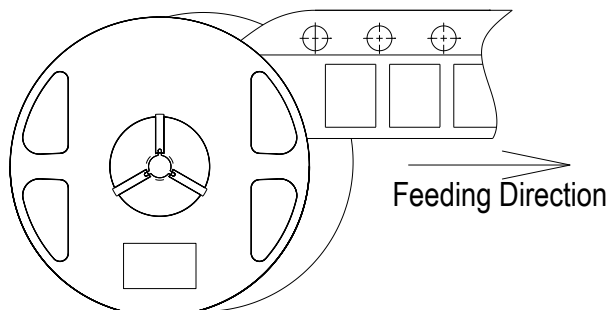
1). $60 \pm 3^{\circ}\text{C}$ X 24hrs and $<5\%$ RH, for reel

2). $125 \pm 3^{\circ}\text{C}$ X 2hrs, for single LED

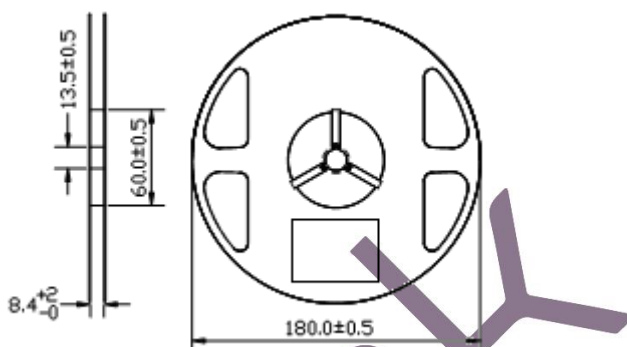
It shall be normal to see slight color fading of carrier (light yellow) after baking in process

■ Packing

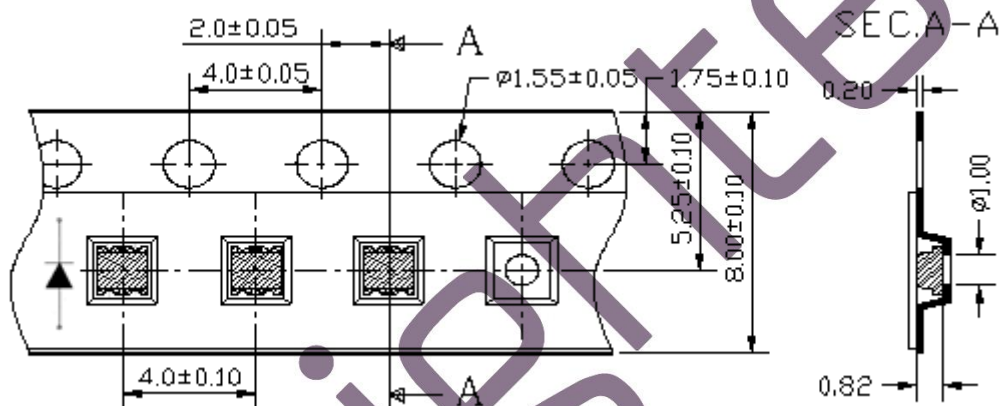
● Feeding Direction



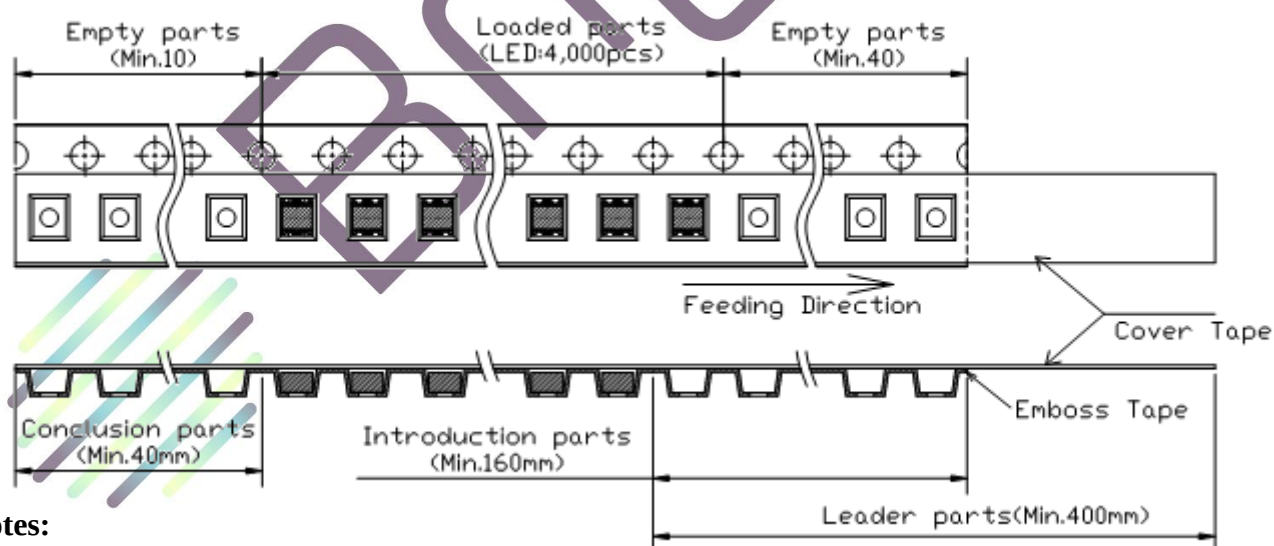
● Dimensions of Reel (Unit: mm)



● Dimensions of Tape (Unit: mm)



● Arrangement of Tape

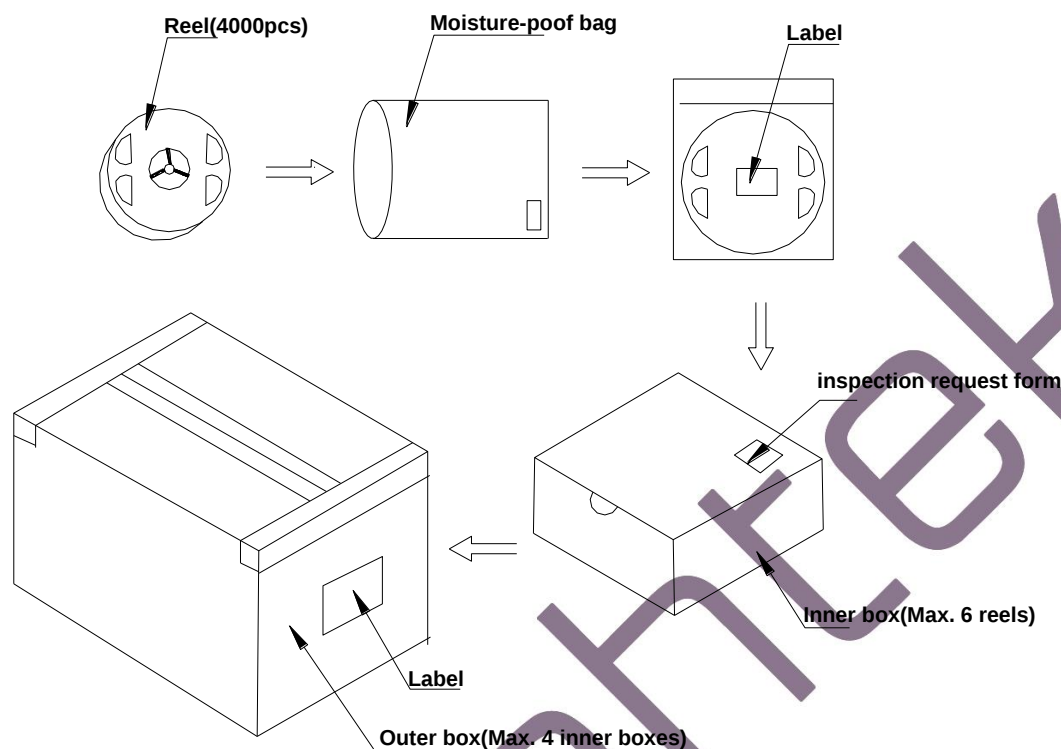


Notes:

1. Empty component pockets are sealed with top cover tape;
2. The max loss number is 2pcs;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
4. 4000pcs/Reel

■ Packing

● Packaging Specifications



Notes:

Reeled product (max.4,000) is packed in a sealed moisture-proof bag. Six bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-proof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.



■ Precautions

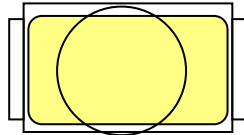
1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

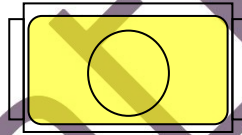
2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area



Picture 1(✓)

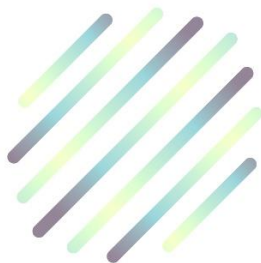


Picture 2(X)

3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

4. This usage and handling instruction is only for your reference.



■ Test Items and Results of Reliability

Test Item	Test Conditions	Duration/ Cycle	Ac/Re	Number of Damage	Reference
Normal Temperature Work	T _a = 23°C (±5°C) I _F = 20mA	1008 hrs	0/1	0/22	JESD22 A-108
High Temperature Work	T _a = 85°C (±5°C) I _F = 20mA	1008 hrs	0/1	0/22	JESD22 A-108
High Humidity Heat Work	T _a = 85°C (±5°C) RH = 85% I _F = 20mA	1008 hrs	0/1	0/22	JESD22 A-108
Thermal shock	-45°C / 30min ~ 105°C / 30min (±5°C)	1008 hrs	0/1	0/22	JESD22 A-104
Electrostatic Discharge (ESD) Test	According to the SPEC	3 cycles	0/1	0/22	AEC Q101-001
Low Temperature Storage	T _a = -40°C	1008 hrs	0/1	0/22	JESD22-A103D
High Temperature Storage	T _a = 125°C	1008 hrs	0/1	0/22	JESD22-A103D

*Criteria for Judging				
Item	Symbol	Condition	Criteria for Judgment of Pass	
			Min	Max
Forward Voltage	V _F	I _F = 5mA	-	USL* ¹ × 1.1
Reverse Current	I _R	V _R = 5V	-	10μA
Luminous Intensity	I _v	I _F = 5mA	LSL* ² × 0.7	-

[Note] USL*¹: Upper Specification Level

LSL*²: Lower Specification Level